

# **DATA SHEET**

## **GENERAL PURPOSE CHIP RESISTORS**

RC\_L series ±0.1%, ±0.5%, ±1%, ±5%

Sizes 0075/0100/0201/0402/0603/0805/ 1206/1210/1218/2010/2512

RoHS compliant & Halogen free



YAGEO Phícomp



#### SCOPE

This specification describes RC series chip resistors with lead free terminations made by thick film process.

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#### <u>APPLICATIONS</u>

• All general purpose application

#### **FEATURES**

- Halogen Free Epoxy
- RoHS compliant
  - · Products with lead free terminations meet RoHS requirements
  - Pb-glass contained in electrodes, resistors element and glass are exempted by **RoHS**
- Reducing environmentally hazardous wastes
- High component and equipment reliability
- Saving of PCB space
- None forbidden-materials used in products/production

#### ORDERING INFORMATION - GLOBAL PART NUMBER

Global part numbers are identified by the series, size, tolerance, packing type, temperature coefficient, taping reel and resistance value.

#### **GLOBAL PART NUMBER**

#### RC XXXX X X X XX XXXX L

(2) (3) (4) (5) (1)

#### (I) SIZE

0075/0100/0201/0402/0603/0805/1206/1210/1218/2010/2512

#### (2) TOLERANCE

 $B = \pm 0.1\%$ 

 $D = \pm 0.5\%$ 

 $F = \pm 1.0\%$ 

 $J = \pm 5.0\%$  (for jumper ordering, use code of J)

#### (3) PACKAGING TYPE

R = Paper taping reel

K = Embossed taping reel

S = ESD safe reel (0075/0100 only)

#### (4) TEMPERATURE COEFFICIENT OF RESISTANCE

- = Based on spec.

#### (5) TAPING REEL

07= 7 inch dia, Reel

13=13 inch dia. Reel

7W = 7 inch dia. Reel &  $2 \times$  standard power

7N = 7 inch dia. Reel, ESD safe reel (0075/0100 only)

#### (6) RESISTANCE VALUE

There are 2~4 digits indicated the resistance value.

Letter R/K/M is decimal point

Example:

 $97R6 = 97.6\Omega$ 

 $9K76 = 9760\Omega$ 

 $IM = 1,000,000\Omega$ 

#### (7) DEFAULT CODE

Letter L is the system default code for ordering only.(Note)

#### **ORDERING EXAMPLE**

The ordering code for a RC0402 0.0625W chip resistor value  $100K\Omega$ with ±5% tolerance, supplied in 7-inch tape reel of 10,000 units per reel is: RC0402JR-07100KL.

#### NOTE

- I. All our RSMD products meet RoHS compliant and Halogen Free. "LFP" of the internal 2D reel label mentions "Lead Free Process".
- 2. On customized label, "LFP" or specific symbol can be printed.



#### MARKING

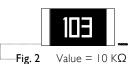
#### RC0075 / RC0100 / RC0201 / RC0402



No Marking

\_\_Fig. I

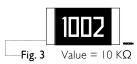
#### RC0603



E24 series: 3 digits

First two digits for significant figure and 3rd digit for number of zeros

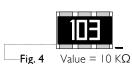
#### RC0805 / RC1206 / RC1210 / RC2010 / RC2512



E24/E96 series: 4 digits

First three digits for significant figure and 4th digit for number of zeros

#### RC1218



E-24 series: 3 digits, ±5%

First two digits for significant figure and 3rd digit for number of zeros



Both E-24 and E-96 series: 4 digits,  $\pm 1\%$  &  $\pm 0.5\%$ 

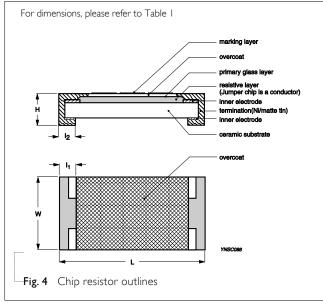
First three digits for significant figure and 4th digit for number of zeros

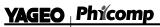
For further marking information, please see special data sheet "Chip resistors marking".

#### CONSTRUCTION

The resistor is constructed on top of a high-grade ceramic body. Internal metal electrodes are added on each end to make the contacts to the thick film resistive element. The composition of the resistive element is a noble metal imbedded into a glass and covered by a second glass to prevent environmental influences. The resistor is laser trimmed to the rated resistance value. The resistor is covered with a protective epoxy coat, finally the two external terminations (matte tin on Nibarrier) are added, as shown in Fig.4.

#### **Outlines**





Chip Resistor Surface Mount

RC\_L

SERIES **0075 to 2512** 

## <u>DIMENSION</u>

Table I

TYPE	L (mm)	W (mm)	H (mm)	I <sub>I</sub> (mm)	l <sub>2</sub> (mm)
RC0075	0.30±0.01	0.15±0.01	0.10±0.01	0.08±0.03	0.08±0.03
RC0100	0.40±0.02	0.20±0.02	0.13±0.02	0.10±0.03	0.10±0.03
RC0201	0.60±0.03	0.30±0.03	0.23±0.03	0.10±0.05	0.15±0.05
RC0402	1.00±0.05	0.50±0.05	0.35±0.05	0.20±0.10	0.25±0.10
RC0603	1.60±0.10	0.80±0.10	0.45±0.10	0.25±0.15	0.25±0.15
RC0805	2.00±0.10	1.25±0.10	0.50±0.10	0.35±0.20	0.35±0.20
RC1206	3.10±0.10	1.60±0.10	0.55±0.10	0.45±0.20	0.40±0.20
RC1210	3.10±0.10	2.60±0.15	0.50±0.10	0.45±0.15	0.50±0.20
RC1218	3.10±0.10	4.60±0.10	0.55±0.10	0.45±0.20	0.40±0.20
RC2010	5.00±0.10	2.50±0.15	0.55±0.10	0.45±0.15	0.50±0.20
RC2512(IW)	6.35±0.10	3.10±0.15	0.55±0.10	0.60±0.20	0.50±0.20
RC2512(2W)	6.35±0.10	3.10±0.15	0.55±0.10	0.60±0.20	1.15±0.20

## **ELECTRICAL CHARACTERISTICS**

Table 2

CHARAC- TERISTICS	POWER	OPERATING TEMPERATURE RANGE	MAXIMUM WORKING VOLTAGE	MAXIMUM OVERLOAD VOLTAGE	DIELECTRIC WITHSTANDING VOLTAGE	RESISTANCE RANGE		JUMPER CRITERIA
RC0075	1/50 W	-55°C to 125°C	10V	25V	25V	5% (E24) I 0Ω≦R≦I MΩ I% (E24/E96) I 0Ω≦R≦I MΩ Jumper<50mΩ	10Ω≦R<100Ω -200~+600ppm°C 100Ω≦R≦1MΩ ±200ppm°C	Rated Current 0.5A Maximum Current 1.0A
RC0100	1/32 W	-55°C to 125°C	15V	30V	30V	5% (E24) IΩ≦R≦22MΩ I% (E24/E96) IΩ≦R≦10MΩ 0.5% (E24/E96) 33Ω≦R≦470KΩ Jumper<50mΩ	$I\Omega \le R < I0\Omega$ $-200 \sim +600 ppm^{\circ}C$ $I0\Omega \le R < I00\Omega:$ $\pm 300 ppm/^{\circ}C$ $I00\Omega \le R \le I0M\Omega:$ $\pm 200 ppm/^{\circ}C$ $I0M\Omega < R \le 22M\Omega:$ $\pm 250 ppm/^{\circ}C$	Rated Current 0.5A Maximum Current 1.0A
RC0201	1/20 W	-55°C to 125°C	25V	50V	50V	5% (E24) IΩ≦R≦I0MΩ I% (E24/E96) IΩ≦R≦I0MΩ 0.1%, 0.5% (E24/E96) I0Ω≦R≦IMΩ Jumper<50mΩ	IΩ≦R≦I0Ω -100~+350ppm°C I0Ω <r≦i0mω ±200ppm°C</r≦i0mω 	Rated Current 0.5A Maximum Current 1.0A

Table 2								
CHARAC- TERISTICS	POWER	OPERATING TEMPERATURE RANGE	MAXIMUM WORKING VOLTAGE	MAXIMUM OVERLOAD VOLTAGE	DIELECTRIC WITHSTANDING VOLTAGE	resistance range	TEMPERATURE COEFFICIENT	JUMPER CRITERIA
RC0402	1/16 W	-55°C to 155°C	50∨	100V	100V	5% (E24) IΩ≦R≦22MΩ I% (E24/E96) IΩ≦R≦10MΩ 0.1%, 0.5% (E24/E96) I0Ω≦R≦IMΩ Jumper<50mΩ	$\begin{split} & 1\Omega \leqq R \leqq 10\Omega \\ & \pm 200 ppm ^{\circ}C \\ & 10\Omega < R \leqq 10M\Omega \\ & \pm 100 ppm ^{\circ}C \\ & 10M\Omega < R \leqq 22M\Omega \\ & \pm 200 ppm ^{\circ}C \end{split}$	Rated Current I.0A Maximum Current 2.0A
	1/8W	-55°C to 155°C	50V	100V	100V	5% (E24) IΩ≦R≦IMΩ I% (E24/E96) IΩ≦R≦IMΩ	IΩ≦R≦IMΩ ±200ppm°C	
RC0603	1/10 W	-55°C to 155°C	75V	150V	150V	5% (E24) $IΩ≦R≦22MΩ$ $I%$ (E24/E96) $IΩ≦R≦10MΩ$ $0.1%$ , $0.5%$ (E24/E96) $I0Ω≦R≦1MΩ$ Jumper< $50mΩ$	IΩ≦R≦I0Ω ±200ppm°C I0Ω <r≦i0mω ±I00ppm°C I0MΩ<r≦22mω ±200ppm°C</r≦22mω </r≦i0mω 	Rated Current I.0A Maximum Current 2.0A
	1/5 W	-55℃ to 155℃	75V	150V	150V	5% (E24) IΩ≦R≦IMΩ I% (E24/E96) IΩ≦R≦IMΩ	IΩ≦R≦IMΩ ±200ppm°C	
RC0805	1/8 W	-55°C to 155°C	150V	300V	300V	5% (E24) IΩ≦R≦22MΩ I% (E24/E96) IΩ≦R≦10MΩ 0.1%, 0.5% (E24/E96) I0Ω≦R≦1MΩ 5%, 10%, 20% (E24) 24MΩ≦R≤50MΩ Jumper<50mΩ	$I\Omega$ ≦R $\leq$ 10 $\Omega$ $\pm$ 200ppm°C $I0\Omega$ <r<math>\leq10M<math>\Omega</math> <math>\pm</math>100ppm°C <math>I0M\Omega</math><r<math>\leq22M<math>\Omega</math> <math>\pm</math>200ppm°C 24M<math>\Omega</math><r<math>\leq50M<math>\Omega</math> <math>\pm</math>300ppm°C</r<math></r<math></r<math>	Rated Current 2.0A Maximum Current 5.0A
	1/4 W	-55℃ to 155℃	150V	300V	300V	5% (E24) IΩ≦R≦IMΩ I% (E24/E96) IΩ≦R≦IMΩ	IΩ≦R≦IMΩ ±200ppm°C	
RC1206	1/4 W	-55°C to 155°C	200V	400V	500V	5% (E24)  IΩ≦R≦22MΩ I% (E24/E96) IΩ≦R≦10MΩ 0.1%, 0.5% (E24/E96) I0Ω≦R≦1MΩ 5%, 10%, 20% (E24) 24MΩ≦R≦50MΩ Jumper<50mΩ	$\begin{split} & I\Omega \leqq R \leqq I0\Omega \\ & \pm 200 ppm^{\circ}C \\ & I0\Omega < R \leqq I0M\Omega \\ & \pm I00 ppm^{\circ}C \\ & I0M\Omega < R \leqq 22M\Omega \\ & \pm 200 ppm^{\circ}C \\ & 24M\Omega \leqq R \leqq 50M\Omega \\ & \pm 300 ppm^{\circ}C \end{split}$	Rated Current 2.0A Maximum Current 10.0A
	1/2 W	-55°C to 155°C	200V	400V	500V	5% (E24) ΙΩ≦R≦ΙΜΩ Ι% (E24/E96) ΙΩ≦R≦ΙΜΩ	IΩ≦R≦IMΩ ±200ppm°C	

SERIES 0075 to 2512

## FOOTPRINT AND SOLDERING PROFILES

For recommended footprint and soldering profiles, please refer to data sheet "Chip resistors mounting"

-	Tab	le	2	
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CHARAC- TERISTICS	POWER	OPERATING TEMPERATURE RANGE	MAXIMUM WORKING VOLTAGE	MAXIMUM OVERLOAD WI VOLTAGE	DIELECTRIC THSTANDING VOLTAGE	RESISTANCE RANGE	TEMPERATURE COEFFICIENT	JUMPER CRITERIA
RC1210	1/2 W	-55°C to 155°C	200V	500V	500V	5% (E24) IΩ≦R≦22MΩ I% (E24/E96) IΩ≦R≦10MΩ 0.1%, 0.5% (E24/E96) I0Ω≦R≦IMΩ Jumper<50mΩ	IΩ≦R≦I0Ω ±200ppm°C I0Ω <r≦i0mω ±100ppm°C I0MΩ<r≦22mω ±200ppm°C</r≦22mω </r≦i0mω 	Rated Current 2.0A Maximum Current 10.0A
RC1218	ΙW	-55°C to 155°C	200V	500V	500V	5% (E24) IΩ≦R≦IMΩ I% (E24/E96) IΩ≦R≦IMΩ 0.1%, 0.5% (E24/E96) I0Ω≦R≦IMΩ Jumper<50mΩ	IΩ≦R≦I0Ω ±200ppm°C I0Ω <r≦imω ±100ppm°C</r≦imω 	Rated Current 6.0A Maximum Current 10.0A
RC2010	3/4 W	-55°C to 155°C	200V	500V	500∨	5% (E24) IΩ≦R≦22MΩ I% (E24/E96) IΩ≦R≦10MΩ 0.1%, 0.5% (E24/E96) I0Ω≦R≦IMΩ Jumper<50mΩ	IΩ≦R≦I0Ω ±200ppm°C I0Ω <r≦i0mω ±I00ppm°C I0MΩ<r≦22mω ±200ppm°C</r≦22mω </r≦i0mω 	Rated Current 2.0A Maximum Current 10.0A
RC2512	ΙW	-55°C to 155°C	200V	500V	500V	5% (E24) IΩ≦R≦22MΩ I% (E24/E96) IΩ≦R≦10MΩ 0.1%, 0.5% (E24/E96) I0Ω≦R≦IMΩ Jumper<50mΩ	IΩ≦R≦I0Ω ±200ppm°C I0Ω <r≦i0mω ±I00ppm°C I0MΩ<r≦22mω ±200ppm°C</r≦22mω </r≦i0mω 	Rated Current 2.0A Maximum Current 10.0A
	2 W	-55°C to 155°C	200V	400V	500V	5% (E24) IΩ≦R≦IMΩ I% (E24/E96) IΩ≦R≦IMΩ	IΩ≦R≦IMΩ ±200ppm°C	

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#### PACKING STYLE AND PACKAGING QUANTITY

Table 3 Packing style and packaging quantity

PACKING STYLE	PAPER TAPING R	EEL (R)	ESD SAFE REEL (S) (4MM WIDTH, IMM PITCH PLASTIC EMBOSSED)	EMBOSSED TAPING REEL
REEL DIMENSION	7" (178 mm)	13" (330 mm)	7" (178 mm)	7" (178 mm)
RC0075			20,000	
RC0100	20,000	80,000	40,000	
RC0201	10,000	50000		
RC0402	10,000	50000		
RC0603	5,000	20000		
RC0805	5,000	20000		
RC1206	5,000	20000		
RC1210	5,000	20000		
RC1218				4,000
RC2010				4,000
RC2512				4,000

#### NOTE

For tape and reel specification/dimensions, please refer to data sheet "Chip resistors packing".

## **FUNCTIONAL DESCRIPTION**

## **OPERATING TEMPERATURE RANGE**

RC0402 to RC2512 Range: -55°C to +155°C (Fig. 5-1)

RC0075 to RC0201 Range: -55°C to +125°C (Fig. 5-2)

#### **POWER RATING**

Each type rated power at 70 °C:

RC0075=1/50W

RC0100=1/32W

RC0201=1/20W

RC0402=1/16W, 1/8W

RC0603=1/10W, 1/5W

RC0805=1/8W, 1/4W

RCI206=I/4W, I/2W

RC1210=1/2W

RC1218=1W

RC2010=3/4W

RC2512=1W, 2W

## **RATED VOLTAGE**

The DC or AC (rms) continuous working voltage corresponding to the rated power is determined by the following formula:

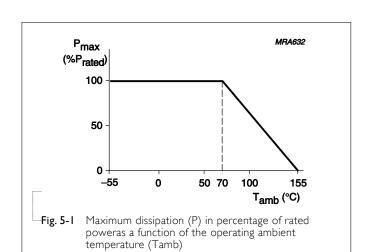
$$V = \sqrt{(PxR)}$$

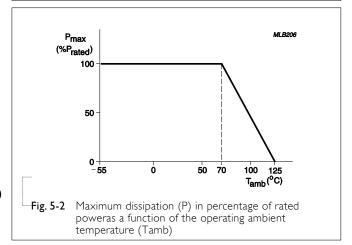
Where

V = Continuous rated DC or AC (rms) working voltage (V)

P = Rated power (W)

 $R = Resistance value (\Omega)$ 





SERIES **0075 to 2512** 

## TESTS AND REQUIREMENTS

## Table 8 Test condition, procedure and requirements

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Temperature Coefficient of Resistance	MIL-STD-202 Method 304	At +25/-55 °C and +25/+125 °C	Refer to table 2
(T.C.R.)		Formula:	
		T.C.R= $\frac{R_2 - R_1}{R_1(t_2 - t_1)} \times 10^6 \text{ (ppm/°C)}$	
		Where	
		t <sub>1</sub> =+25 ° <b>C</b> or specified room temperature	
		t <sub>2</sub> =–55 °C or +125 °C test temperature	
		R <sub>1</sub> =resistance at reference temperature in ohms	
		R <sub>2</sub> =resistance at test temperature in ohms	
Life/ Endurance	MIL-STD-202 Method 108A IEC 60115-1 4.25.1	At 70±2° <b>C</b> for 1,000 hours; RCWV applied for 1.5 hours on and 0.5 hour off, still air required	0075: $\pm$ (5%+100m $\Omega$ ) <100m $\Omega$ for jumper 01005: $\pm$ (3% +50m $\Omega$ ) <100m $\Omega$ for jumper
			Others:
			$\pm (1\% + 50 \text{m}\Omega)$ for B/D/F tol
			$\pm (3\% + 50 \text{m}\Omega)$ for J tol
			<100mR for jumper
High Temperature Exposure	MIL-STD-202 Method 108A IEC 60068-2-2	I,000 hours at maximum operating temperature depending on specification, unpowered.	0075: $\pm$ (5%+100m $\Omega$ ) <100m $\Omega$ for jumper 01005: $\pm$ (1% +50m $\Omega$ )
Exposure			$<$ 50m $\Omega$ f or jumper
			Others:
			$\pm (1\% + 50 \text{m}\Omega)$ for B/D/F tol
			$\pm (2\% + 50 \text{m}\Omega)$ for J tol
			<50mR for jumper
Moisture Resistance	MIL-STD-202 Method I06G	Each temperature / humidity cycle is defined at 8 hours (method 106F), 3 cycles / 24 hours for 10d with 25 °C / 65 °C 95% R.H, without steps	0075: $\pm$ (2%+100m $\Omega$ ) <100m $\Omega$ for jumper 01005: $\pm$ (2% +50m $\Omega$ ) < 100m $\Omega$ f or jumper
		7a & 7b, unpowered	Others:
		Parts mounted on test-boards, without	$\pm (0.5\% + 50 \text{m}\Omega)$ for B/ D/F tol
		condensation on parts	$\pm (2\% + 50 \text{m}\Omega)$ for J tol
			<100mR for jumper
Humidity	IEC 60115-1 4.24.2	Steady state for 1000 hours at 40 °C / 95% R.H. RCWV applied for 1.5 hours on and	0075: $\pm$ (5%+100m $\Omega$ ) no visible damage 01005: $\pm$ (3% +50m $\Omega$ )
		0.5 hour off	$<$ 100m $\Omega$ f or jumper
			Others:
			$\pm (1\% + 50 \text{m}\Omega)$ for B/D/F tol
			$\pm (2\% + 50 \text{m}\Omega)$ for J tol
			<100mR for jumper

Note Number of cycles required is 300. Devices mounted Maximum transfer time is 20 seconds. Dwell time is 15 minutes. Air - Air	$$<50 \text{m}\Omega$f$ or jumper Others: $\pm (0.5\% + 50 \text{m}\Omega) \text{ for B/D/F tol}$
Dwell time is 15 minutes. Air - Air	$\pm (0.5\% + 50 \text{m}\Omega)$ for B/D/F tol
	$\pm (1\% + 50 \text{m}\Omega)$ for J tol
	<50mR for jumper
2.5 times RCWV or maximum overload voltage which is less for 5 seconds at room temperature	$0075/01005$ : $\pm (2\% + 50m\Omega)$ < $50m\Omega$ f or jumper
	Others:
	$\pm (1\% + 50 \text{m}\Omega)$ for B/D/F tol
	$\pm (2\% + 50 \text{m}\Omega)$ for J tol
	<50mR for jumper
	No visible damage
Device mounted or as described only I board bending required bending time: 60±5 seconds 0075/0100/0201/0402:5mm; 0603/0805:3mm; 1206 and above:2mm	0075/01005: $\pm (1\% + 50m\Omega)$ $< 50m\Omega$ f or jumper Others: $\pm (1\% + 50m\Omega)$ for B/D/F/J Tol < 50mR for jumper No visible damage
Electrical Test not required Magnification 50X SMD conditions:  Ist step: method B, aging 4 hours at 155 °C dry heat  2nd step: leadfree solder bath at 245±3 °C Dipping time: 3±0.5 seconds	W ell tinned (>95% covered) No visible damage
Leadfree solder ,260°C, 30 seconds immersion time	No visible damage
Container By the promode of samples	0075: $\pm$ (3%+50m $\Omega$ ) <50m $\Omega$ for jumper
Leadfree solder, 260 $^{\circ}$ C $\pm$ 5 $^{\circ}$ C, 10 $\pm$ 1 seconds immersion time	01005: $\pm (1\% + 50 \text{m}\Omega)$
Procedure 2 for SMD: devices fluxed and	$<$ 50m $\Omega$ f or jumper
cleaned with isopropanol	Others:
	$\pm (0.5\% + 50 \mathrm{m}\Omega)$ for B/D/F
	tol. $\pm$ (1% +50m $\Omega$ ) for J tol.
	<50mR for jumper No visible damage
	Device mounted or as described only I board bending required bending time: 60±5 seconds 0075/0100/0201/0402:5mm; 0603/0805:3mm; 1206 and above:2mm  Electrical Test not required Magnification 50X SMD conditions: Ist step: method B, aging 4 hours at 155 °C dry heat 2nd step: leadfree solder bath at 245±3 °C Dipping time: 3±0.5 seconds  Leadfree solder ,260°C, 30 seconds immersion time  210F Condition B, no pre-heat of samples Leadfree solder, 260 °C ±5°C, 10±1 seconds immersion time  Procedure 2 for SMD: devices fluxed and

**Chip Resistor Surface Mount** 

RC\_L

## **REVISION HISTORY**

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 4	Jan. 22, 2016	-	- update resistance range
Version 3	Dec. 24, 2015	-	- Updated test and requirements
Version 2	Jul. 23, 2015	-	- Updated test and requirements
Version I	Jan. 21, 2015	-	- ESD Safe Reel update
Version 0	Dec. 15, 2014	-	- First issue of this specification

<sup>&</sup>quot;Yageo reserves all the rights for revising the content of this datasheet without further notification, as long as the products itself are unchanged. Any product change will be announced by PCN."